

**PATENT ASSIGNMENT**

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

**CONVEYING PARTY DATA**

Name	Execution Date
Sungeun Park	03/22/2011

**RECEIVING PARTY DATA**

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Name:	Ecoyaa Co., Ltd.
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City:	Icheon-si, Gyeonggi-do
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Postal Code:	467-814

**PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	13122486

**CORRESPONDENCE DATA**

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OP \$40.00 13122486

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ATTORNEY DOCKET NUMBER:	NAM-0013-SE
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NAME OF SUBMITTER:	JAE Y. PARK
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Total Attachments: 2 source=assignmentNAM0013#page1.tif source=assignmentNAM0013#page2.tif
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UNITED STATES PATENT RIGHTS, OR  
UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

**ASSIGNMENT**

Insert Name(s)  
and Address(es) WHEREAS, Sungeun PARK of 410, Dongdaemunsangga Apt., 436-79, Changsin-dong, Jongno-gu,  
of Inventor(s) Seoul, 110-540, Republic of Korea,

(hereinafter designated as the undersigned) has invented certain new and useful improvements in

Insert Title  
of Invention DYEING METHOD FOR RAISING BLUE COLOR

which claims priority to PCT Application No. PCT/KR2009/005776, filed on October 9, 2009, and KR  
Application No. 10-2008-0100253 filed on October 13, 2008, for which the undersigned is about to file an  
application for Letters Patent of the United States; and

Insert Name  
and address WHEREAS, Sungeun PARK of 410, Dongdaemunsangga Apt., 436-79, Changsin-dong, Jongno-gu,  
Seoul, 110-540, Republic of Korea;

of Assignees Yunha LEE of 103-702 Worldhanarum Apt., 457, Howon-dong, Uijeongbu-si, Gyeonggi-do,  
480-020, Republic of Korea; and  
Ecovaa Co., Ltd. of 92-1, Ocheon-ri, Majang-myeon, Icheon-si, Gyeonggi-do, 467-814, Republic  
of Korea

their heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) are  
desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters  
Patent(s) that may be granted therefor in the United States of America and in any foreign countries.

NOW, THEREFORE, to all whom it may concern, be it known that, for good and valuable consideration  
paid to the undersigned, the receipt of which is hereby acknowledged, the undersigned has (have) sold,  
assigned and transferred, and by these presents does sell, assign and transfer unto the Assignees the full and  
exclusive right to the said invention in the United States of America, its territories, dependencies and  
possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be  
granted therefor in the United States of America, its territories, dependencies and possessions, and in any  
and all foreign countries;

and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or  
terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any  
continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments  
in connection with such applications as the Assignees may deem necessary or expedient.

The undersigned agree (s) to execute all papers necessary in connection with any interference which may be  
declared concerning this application or continuation, division, conversion or reissue thereof or Letter  
Patent(s) or reissue patent issued thereon and to cooperate with the Assignees in every way possible in  
obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignees of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned declare that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Name of Inventor: Sungeun PARK Signature by K. S. C. Date March 22, 2011